







Resistive Element Thick film

Substrate Aluminum nitride ceramic
Terminals Tin/Lead, 90/10 over nickel

#### **Electrical Specifications**

Resistance Range: 50 ohms,  $\pm$  2% Frequency Range; DC - 2.0 GHz Power: 10 Watts

1054 50

**VSWR** 1.25:1 DC – 2.0 GHz

**Note:** Tolerance is  $\pm 0.010$ ", unless otherwise specified. Designed to meet of exceed applicable portions of MIL-E-5400. Operating temperature is -55°C to 125°C (see chart for derating temperatures).

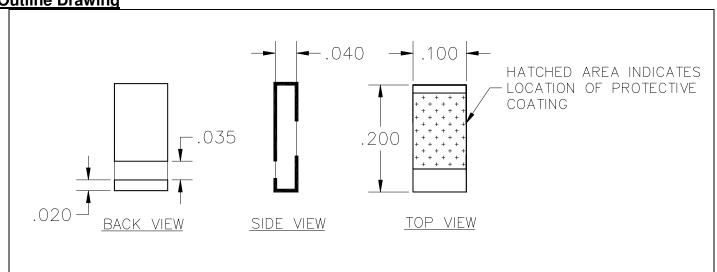
All dimensions in inches.

Specifications subject to change with out notice.

## Features:

- DC 2.0 GHz
- 10 Watts
- AIN Ceramic
- Non-Nichrome Resistive Element
- Low VSWR
- 100% Tested





100200N4Z50-2 (097) Rev A



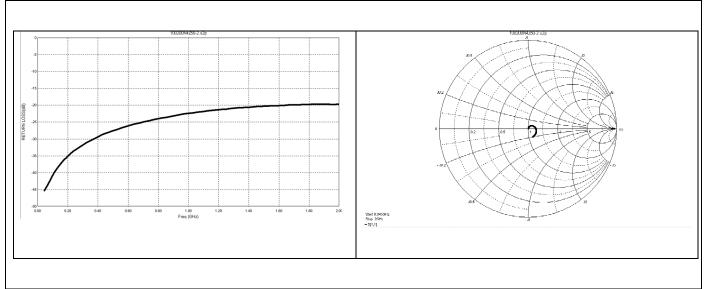


Available on Tape and Reel For Pick and Place Manufacturing. USA/Canada: (315) 432-8909 Toll Free: (800) 544-2414 Europe: +44 2392-232392





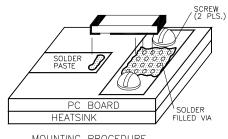
**Typical Performance:** 



## **Power De-rating:**

# POWER DERATING RATED POWER 100 75 50 -25-90 0 -% 25 50 75 100 125 P.C.B. SOLDER INTERFACE TEMPERATURE - °C

## **Mounting Footprint and Procedure:**



MOUNTING PROCEDURE

- 1. Solder part in place using 60/40 type solder with Temperature controlled iron (700°F).
- 2. Drill thermal vias through PCB and fill with solder, such as 60/40 type.
- 3. To ensure good thermal connectivity to heat sink, drill and tap heatsink and mount PCB board to heat sink using screws.

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